# EMF23XV6T5

# **Dual Transistor - Power Management**

## **NPN/PNP Dual (Complementary)**

## **Features**

- Low  $V_{CE(SAT)}$ , < 0.5 V
- These are Pb-Free Devices

## **MAXIMUM RATINGS**

Q

Rating	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	Vdc
Collector-Emitter Voltage	V <sub>CEO</sub>	50	Vdc
Collector Current	Ic	100	mAdc

#### Q2

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	-60	V
Collector - Base Voltage	V <sub>CBO</sub>	-50	V
Emitter - Base Voltage	V <sub>EBO</sub>	-6.0	V
Collector Current - Continuous	I <sub>C</sub>	-100	mAdc

## THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C	$P_{D}$	357	mW
Derate above 25°C		(Note 1) 2.9 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	350 (Note 1)	°C/W
Characteristic			
(Both Junctions Heated)	Symbol	Max	Unit
(Both Junctions Heated)  Total Device Dissipation $T_A = 25^{\circ}C$	Symbol P <sub>D</sub>	500	<b>Unit</b> mW
,			
Total Device Dissipation T <sub>A</sub> = 25°C		500 (Note 1) 4.0	mW

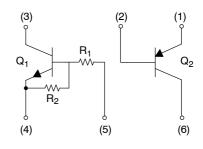
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 @ Minimum Pad.



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SOT-563 CASE 463A STYLE 1

## MARKING DIAGRAM



UW = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
EMF23XV6T5	SOT-563 (Pb-Free)	8000/Tape & Reel
EMF23XV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## EMF23XV6T5

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C)

Characteristic	Symbol	Min	Тур	Max	Unit
Q1: NPN					
Collector-Base Cutoff Current (V <sub>CB</sub> = 50 V, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	-	100	nAdc
Collector-Emitter Cutoff Current (V <sub>CE</sub> = 50 V, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	_	500	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 6.0 \text{ V}, I_{C} = 0$ )	I <sub>EBO</sub>	-	_	0.5	mAdc
Collector-Base Breakdown Voltage ( $I_C = 10 \mu A, I_E = 0$ )	V <sub>(BR)CBO</sub>	50	_	-	Vdc
Collector-Emitter Breakdown Voltage (Note 3) ( $I_C = 2.0$ mA, $I_B = 0$ )	V <sub>(BR)CEO</sub>	50	_	-	Vdc
DC Current Gain (V <sub>CE</sub> = 10 V, I <sub>C</sub> = 5.0 mA)	h <sub>FE</sub>	35	60	-	-
Collector-Emitter Saturation Voltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0.3 mA)	V <sub>CE(sat)</sub>	-	-	0.25	Vdc
Output Voltage (on) (V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 2.5 V, R <sub>L</sub> = 1.0 k $\Omega$ )	V <sub>OL</sub>	-	-	0.2	Vdc
Output Voltage (off) (V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 0.5 V, R <sub>L</sub> = 1.0 k $\Omega$ )	V <sub>OH</sub>	4.9	-	-	Vdc
Input Resistor	R1	7.0	10	13	kΩ
Resistor Ratio	R1/R2	0.8	1.0	1.2	-
Q2: PNP					
Collector–Base Breakdown Voltage ( $I_C = -50 \mu Adc, I_E = 0$ )	V <sub>(BR)CBO</sub>	-60	-	-	Vdc
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = -1.0 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	-50	-	-	Vdc
Emitter-Base Breakdown Voltage ( $I_E = -50 \mu Adc$ , $I_E = 0$ )	V <sub>(BR)EBO</sub>	-6.0	-	-	Vdc
Collector-Base Cutoff Current (V <sub>CB</sub> = -30 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	-	-0.5	nA
Emitter-Base Cutoff Current (V <sub>EB</sub> = -5.0 Vdc, I <sub>B</sub> = 0)	I <sub>EBO</sub>	-	_	-0.5	μΑ
Collector–Emitter Saturation Voltage (Note 3) ( $I_C = -50$ mAdc, $I_B = -5.0$ mAdc)	V <sub>CE(sat)</sub>	_	-	-0.5	Vdc
DC Current Gain (Note 3) (V <sub>CE</sub> = -6.0 Vdc, I <sub>C</sub> = -1.0 mAdc)	h <sub>FE</sub>	120	-	560	-
Transition Frequency (V <sub>CE</sub> = -12 Vdc, I <sub>C</sub> = -2.0 mAdc, f = 30 MHz)	f <sub>T</sub>	-	140	-	MHz
Output Capacitance (V <sub>CB</sub> = -12 Vdc, I <sub>E</sub> = 0 Adc, f = 1.0 MHz)	C <sub>OB</sub>	-	3.5	-	pF

<sup>2.</sup> Device mounted on a FR-4 glass epoxy printed circuit board using the minimum recommended footprint. 3. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, DC  $\leq$  2%.

## TYPICAL ELECTRICAL CHARACTERISTICS — Q1, NPN

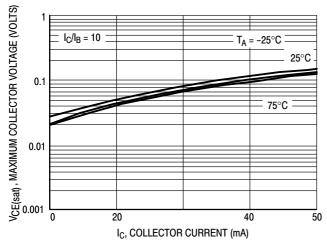


Figure 1. V<sub>CE(sat)</sub> versus I<sub>C</sub>

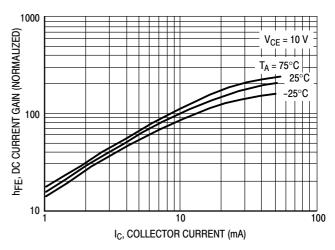


Figure 2. DC Current Gain

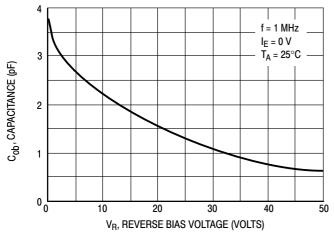


Figure 3. Output Capacitance

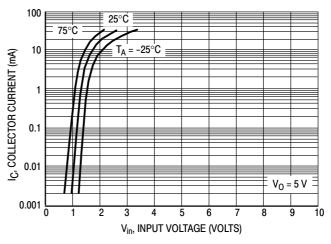


Figure 4. Output Current versus Input Voltage

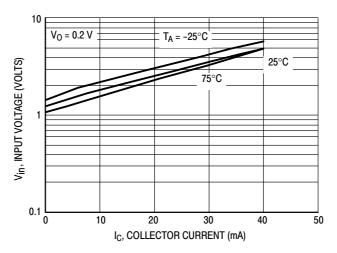
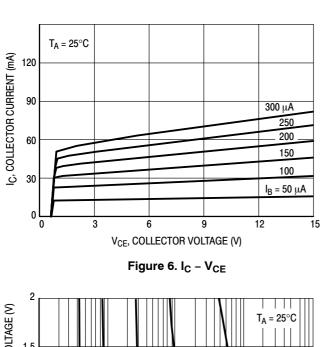


Figure 5. Input Voltage versus Output Current

## EMF23XV6T5

## TYPICAL ELECTRICAL CHARACTERISTICS - Q2, PNP



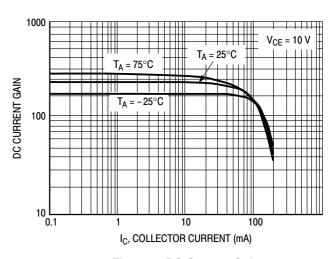
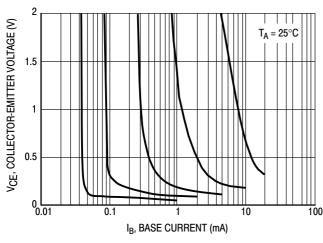


Figure 7. DC Current Gain



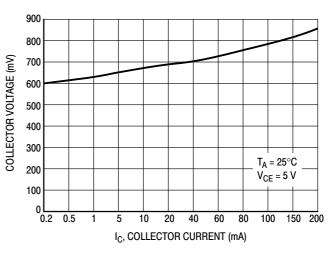
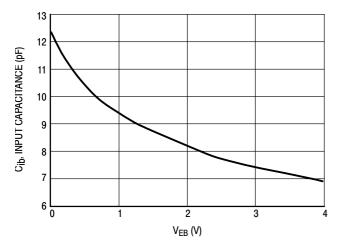


Figure 8. Collector Saturation Region

Figure 9. On Voltage



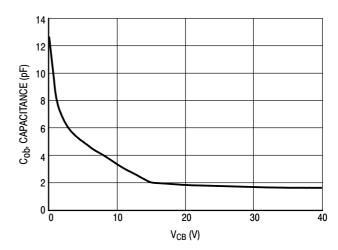


Figure 10. Capacitance

Figure 11. Capacitance



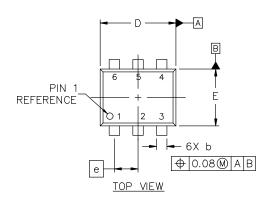


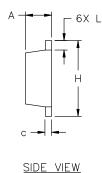
## SOT-563-6 1.60x1.20x0.55, 0.50P CASE 463A **ISSUE J**

**DATE 15 FEB 2024** 

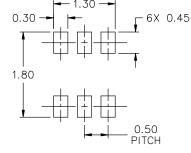
#### NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- ALL DIMENSION ARE IN MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.





DIM	MILLIMETERS		RS
וועם	MIN.	N□M.	MAX.
Α	0.50	0.55	0.60
b	0.17	0.22	0.27
C	0.08	0.13	0.18
D	1.50	1.60	1.70
E	1.10	1.20	1.30
е	0.50 BSC		
Н	1.50	1.60	1.70
L	0.10	0.20	0.30



STYLE 1:	STYLE 2:	STYLE 3:
PIN 1. EMITTER 1	PIN 1. EMITTER 1	PIN 1. CATHODE 1
2. BASE 1	2. EMITTER 2	2. CATHODE 1
3. COLLECTOR 2	3. BASE 2	3. ANODE/ANODE 2
4. EMITTER 2	4. COLLECTOR 2	4. CATHODE 2
5. BASE 2	5. BASE 1	5. CATHODE 2
6. COLLECTOR 1	6. COLLECTOR 1	6. ANODE/ANODE 1

STYLE 6: PIN 1. CATHODE 2. ANODE

3. CATHODE

4. CATHODE 5. CATHODE

CATHODE

RECOMMENDED	MOLINITING	FOOTPRINT*
KECOMIMENDED	MOONTING	LOO INKINI.

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	STYLE 8: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SUURCE 5. DRAIN 6. DRAIN	STYLE 9: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1
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STYLE 5

PIN 1. CATHODE

2. CATHODE 3. ANDDE 4. ANDDE 5. CATHODE

## **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code M = Month Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

PIN 1. CATHODE 1	PIN 1. EMITTER 2
2. N/C	2. BASE 2
3. CATHODE 2	3. COLLECTOR 1
4. ANODE 2	4. EMITTER 1
5. N/C	5. BASE 1
6. ANDDE 1	6. COLLECTOR 2

STYLE 11:

STYLE 4: PIN 1. COLLECTOR

3. BASE 4. EMITTER 5. COLLECTOR

STYLE 10:

2. COLLECTOR

COLLECTOR

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**DESCRIPTION:** SOT-563-6 1.60x1.20x0.55, 0.50P **PAGE 1 OF 1** 

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